
YAMAHA® LSI

YM2151

FM Operator Type-M(OPM)

■ OUTLINE

The YM2151 is an FM-type sound generator equipped with an 8 bit bus line and capable of producing superb audio quality via a microprocessor program. When this IC is used in tandem with the specially-developed YM3012D/A converter, you can obtain 8-note, left-right/2-channel audio signals.

In addition, this unit is equipped with noise, vibrato, an amplitude modulation circuit, a sound effects circuit, and timer.

The package is a 24-pin dual in-line package.

■ FEATURES

- Generate up to 8 notes.
- Generate noise.
- Timbre can be altered temporally.
- High harmonic can be de-harmonized from the base frequency.
- De-harmonize between octaves.
- Interval setting of up to 1.6 cents.
- Add vibrato and amplitude modulation.
- Generate a variety of sound effects by extreme de-harmonization of the high harmonic from the base frequency and massive vibrato and amplitude modulation.

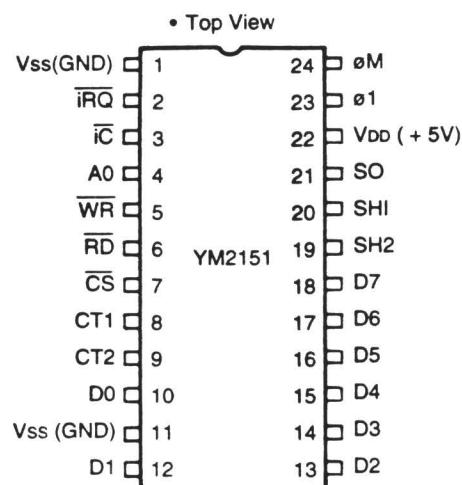
YAMAHA CORPORATION

YM2151 CATALOG

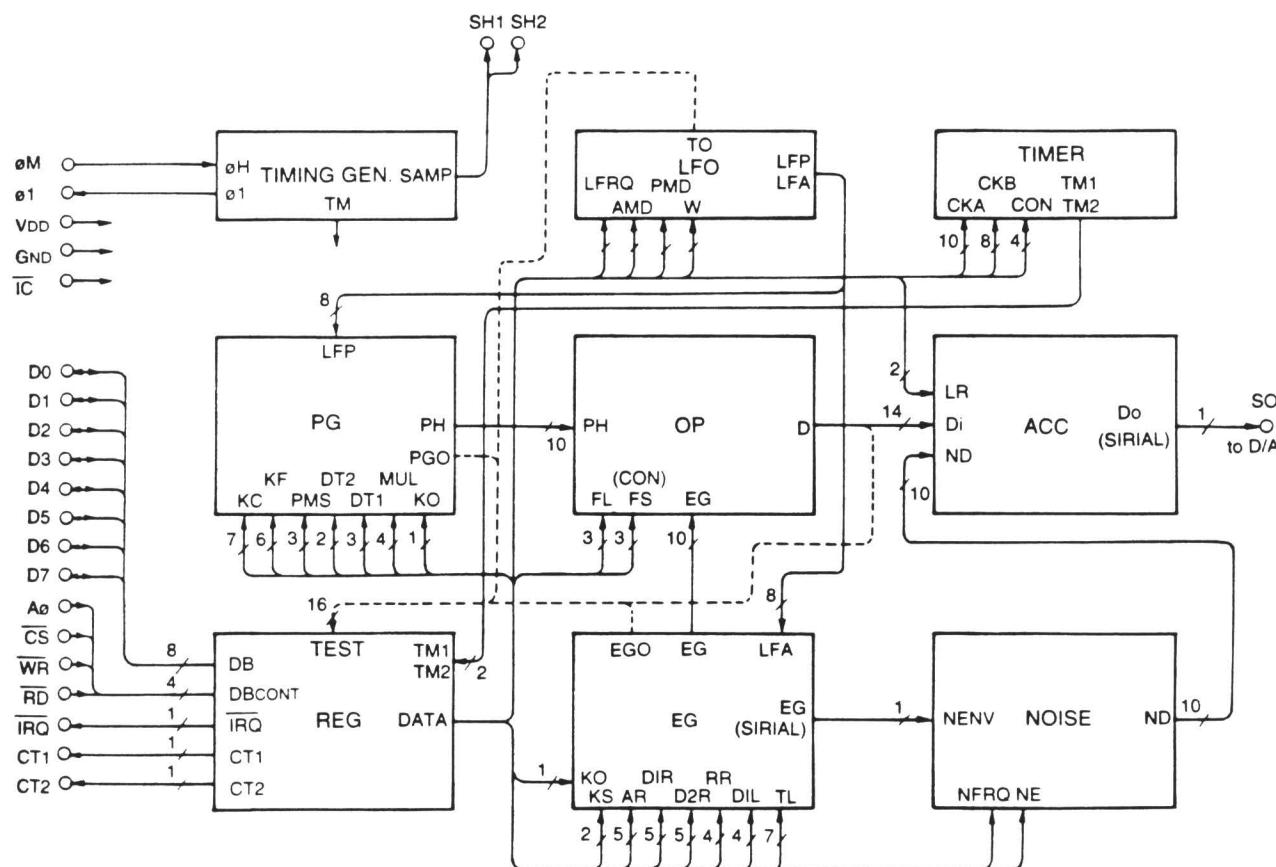
CATALOG No.:LSI-2121512

1991. 12

■ TERMINAL DIAGRAM



■ BLOCK DIAGRAM



■ DESCRIPTION OF TERMINAL FUNCTION

- D₀ ~ D₇: Address/Data Bus (input/output high impedance)

A multiplex bus that can be used for both address and data; inputs an 8-bit parallel signal between an external device and the internal register.
- A₀: Address/Data Select (Input)

When A₀ = "0", the D₀ ~ D₇ signal is process as address signal; when A₀ = "1", the D₀ ~ D₇ signal is processed as data.
- WR: Write (Input)

When WR = "0", the signals in the bus can be entered.
- RD: Read (Input)

When RD = "0", the internal signals can be read out via the bus.
- CS: Chip Select (Input)

When there is a chip select signal, the A₀, WR, and RD sgnals become operative and the D₀ ~ D₇ bus data can be entered in the internal register or internal data can be read out on the D₀ ~ D₇ bus.
- IC: Initial clear (Input)

Internal registers and circuits are initialized when this terminal reads "0".
- iRQ: Interrupt request (Output: Open drain)

If either of the 2 types of timer counters begins a carry out, this signal will read out a "0" level and request an interrupt from the CPU Then, with the CPU's readout of the data, the unit will determine from which timer the interrupt request has been made and will process the interrupt.
- CT1, CT2: Control 1, Control 2 (Output)

This is the terminal that is used to control an external device and should read "0" level when at initial condition.
- SO: Serial Output (Output)

Takes the tone signal divided between the 2 left and right channels, outputs it as serial data, and sends it to the YM3012 D/A converterter specially developed for use with the YM2151.
- SH1, SH2: Sample and hold

Used to pick up the serial data supplied to the YM3012 D/A converter, and for sampling hold after analog conversion.
- øM: System clock (Input)

Inputs the clock øM that drives the YM2151, which is internally broken down to and used at 1/2 the frequency. The øM is the reference for the tone signal.
- ø1: Clock for D/A (output)

This clock drives the D/A and operates at the same frequency as the clock inside the YM2151. Also, when the ø1 level shifts from "1" to "0", the iRQ, CTI, CT2, TO, SH1, SH2, and SO signals all change.
- V_{DD}: Power Supply (Input)

Normally supplies at + 5V.
- V_{ss}: Grand (Input)

Conects the system grand.

*WRITE DATA

Address Map (1); WRITE MODE

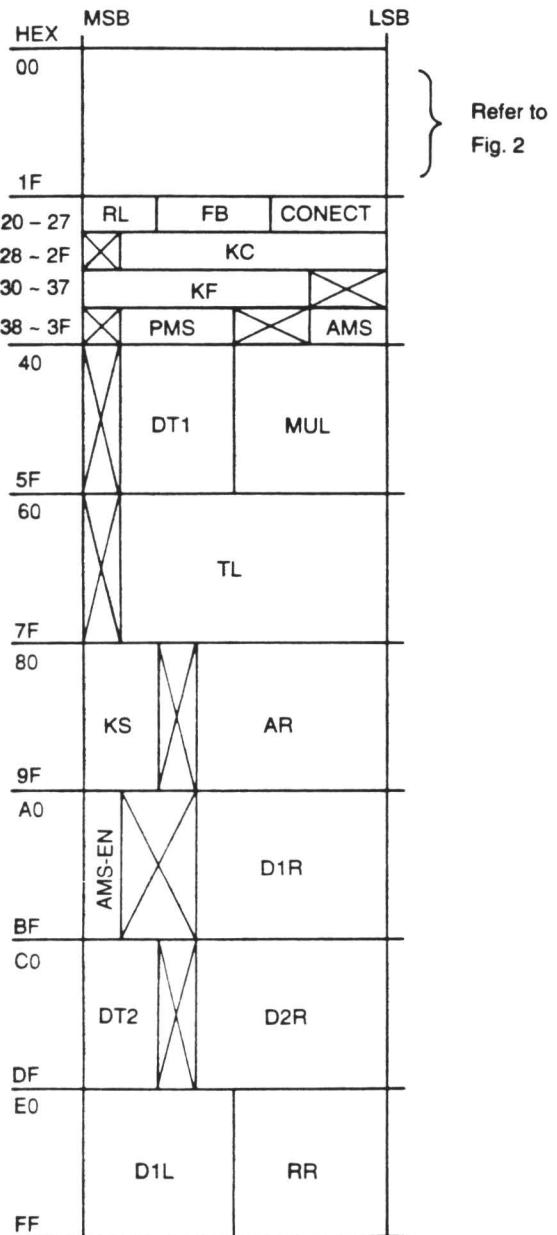
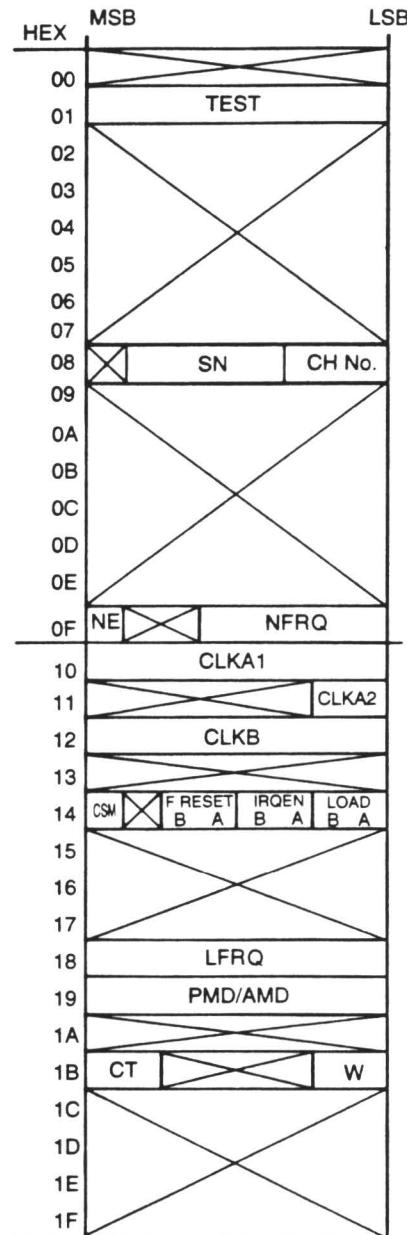


Fig (1)

Address Map (2); WRITE MODE



*F RESET = FLAG RESET

Fig (2)

Address Map (3); READ MODE

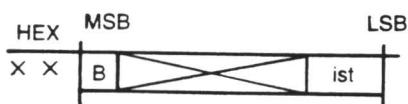
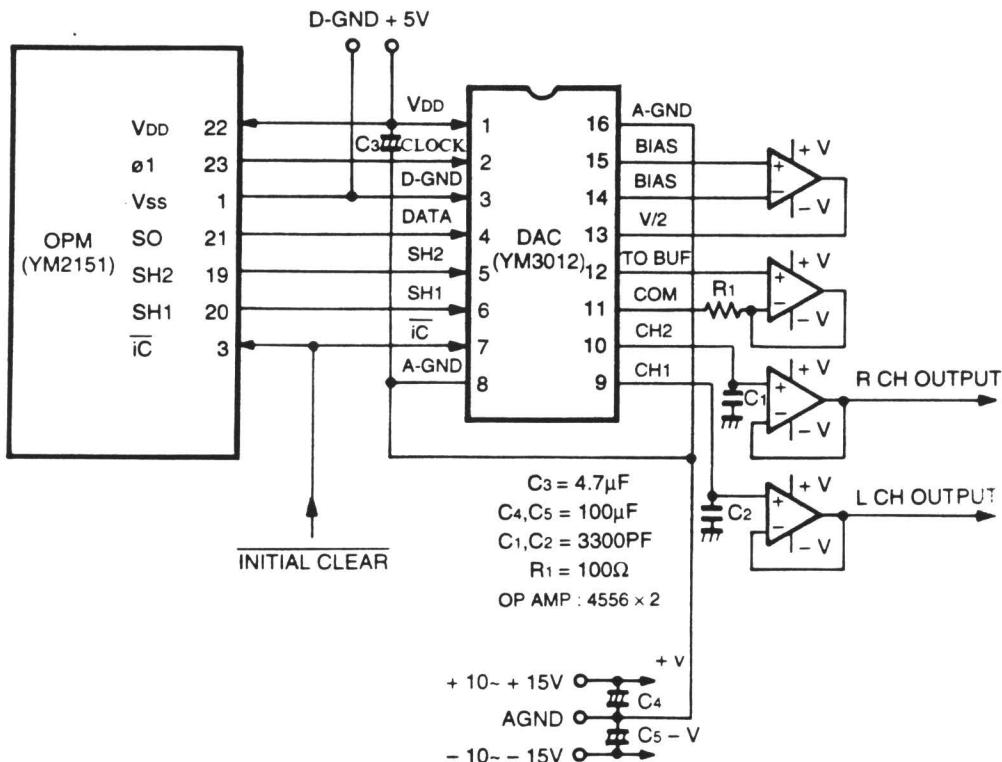


Fig (3)

■ EXAMPLE OF BASIC CIRCUIT



■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Rating

ITEM	RATING	UNIT
Voltage Range	-0.3 ~ +7	V
Operating temperature	0 ~ 70	°C
Storage temperature	-50 ~ +125	°C

2. Recommended Operation Conditions

ITEM	SYMBOL	MIN.	STD.	MAX.	UNIT
Operating supply voltage	V _{DD}	4.75		5.25	V
Power supply current	I _{DD}			120	mA
Power dissipation (at V _{DD} = 5.25V)	P _D			630	mW

Electrical Characteristics**1. Clock**

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Voltage level	"0"		- 0.3		0.8	V
Voltage level	"1"		20		V _{DD}	V
Rise time	T _r	Fig-1			50	ns
Fall time	T _f	Fig-1			50	ns
ON time	T _{ON}	Fig-1	100			ns
Frequency	Ø _M		3.0	3.58	4.0	MHz
Input capacitance	C _{ØM}				10	pF

2. Ø1

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Rise time	T _{r1}	Fig-3			180	ns
Fall time	T _{f1}	Fig-3			120	ns
Load capacitance	C _L				100	pF

3. IRQ, CT1, CT2, SO, SH1, SH2

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Rise time	T _{r2}	Fig-4			250	ns
Fall time	T _{f2}	Fig-4			250	ns
Load capacitance	C _L				100	pF

4. Write/Read Timing

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Address Set-up Timing	T _{AS}	Fig-2	10			ns
Address Hold Timing	T _{AH}	Fig-2	10			ns
<u>CS</u> WRITE WIDTH	T _{CW}	Fig-2	100			ns
<u>WR</u> WRITE WIDTH	T _{WW}	Fig-2-1	100			ns
WRITE DATA Set-up Time	T _{Ds}	Fig-2-1	50			ns
WRITE DATA Hold Time	T _{DHW}	Fig-2-1	10			ns
READ DATA ACCESS Time	T _{ACC}	Fig-2-2			180	ns
READ DATA Hold Time	T _{DHR}	Fig-2-2	10			ns

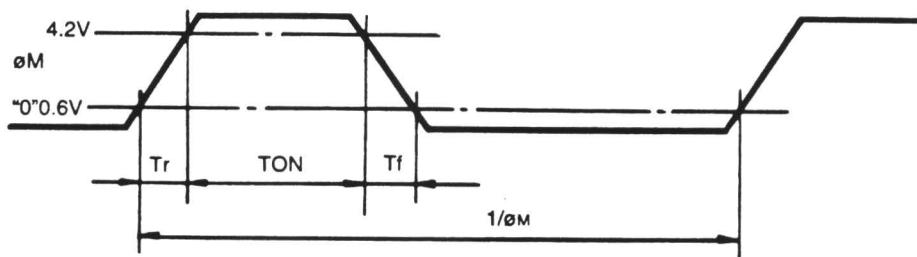


Fig-1 PHASE DATA

5. All Input

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Voltage level	"0"		- 0.3		0.8	V
Voltage level	"1"		2.0		VDD	V

6. All Output

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Voltage level	"0"		- 0.3		0.4	V
Voltage level	"1"		2.4		VDD	V

7. A0, WR, RD, CS, ΦM

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Input Leak Current	I _L	at 25°C V _i = 10V			0.1	μA

8. IC

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Input Current	I _{II0}	V _{DD} = 5V	10		60	μA

9. IRQ*, CT1, CT2, D0-D7, SH1 SH2, SO, Φ1

ITEM	SYMBOL	CONDISIONS	MIN.	STD.	MAX.	UNIT
Load Current	I _D	V _{LO} = 0.4V			2.1	mA

*OPEN DRAIN

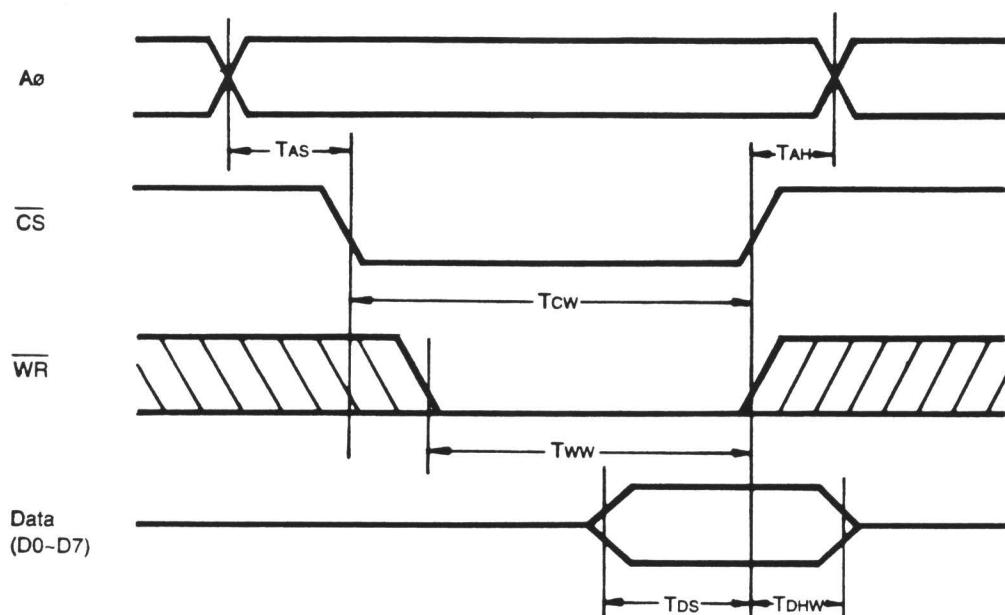


Fig 2-1 WRITE TIMING

NOTE: TDS and TDHW use as a reference either \overline{CS} or \overline{WR} , whichever has attained High Level.

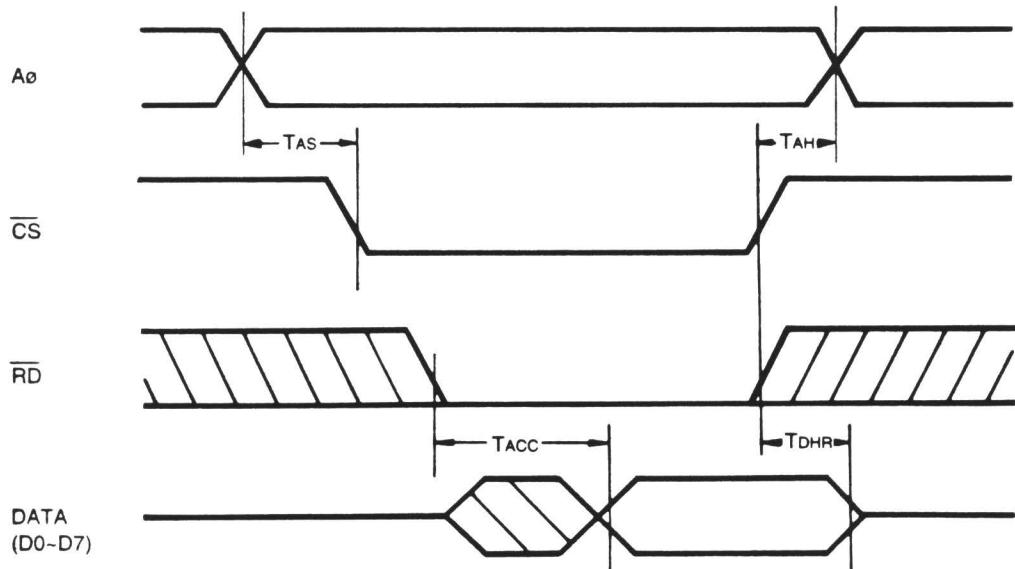


Fig 2-2 READ TIMING

NOTE: TACC use as a reference either \overline{CS} or \overline{RD} , whichever is the last to attain Low Level.
 TDHR uses as a reference either CS or RD, whichever has attained High Level.

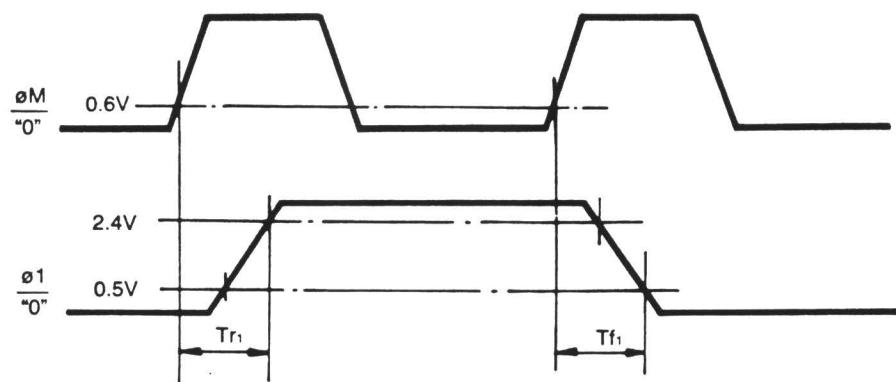


Fig-3

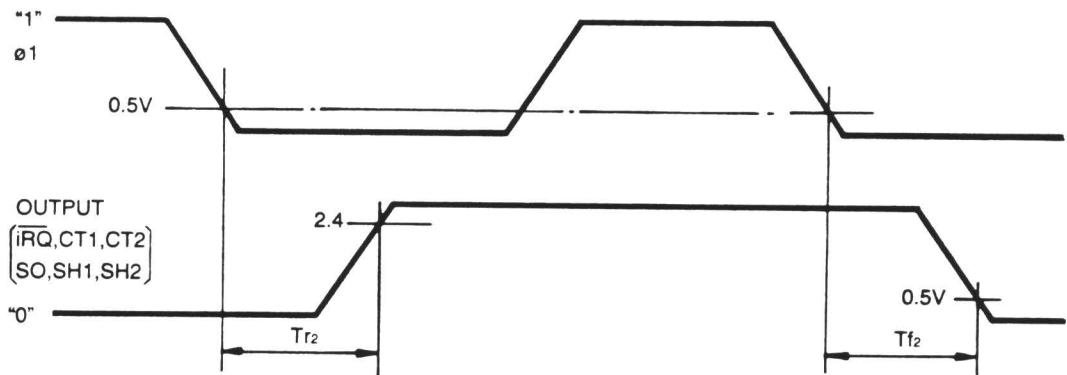


Fig-4

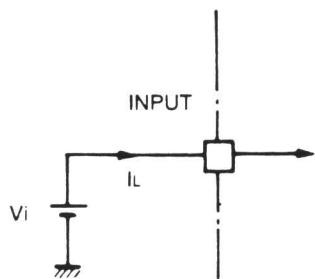


Fig-5

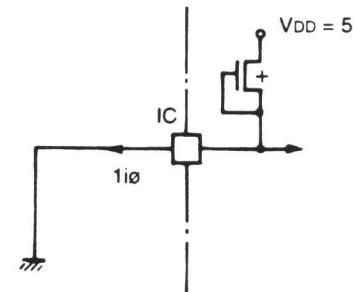


Fig-6

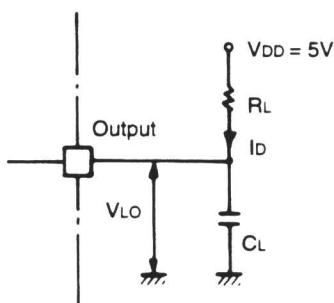
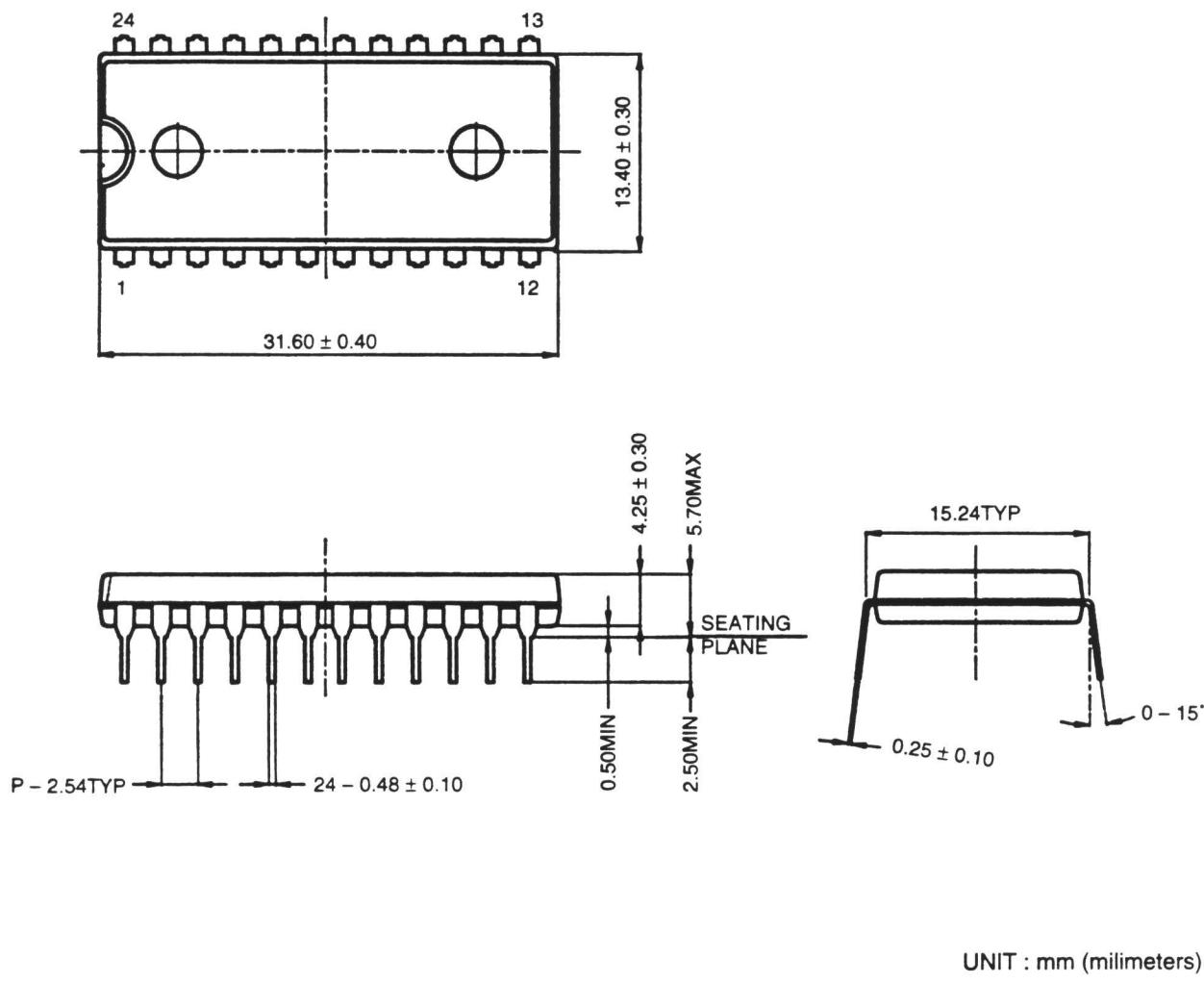


Fig-7

■ EXTERNAL DIMENSIONS



The specifications of this product are subject to improvement changes without prior notice.

AGENCY

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